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Zilog - ZGP323HAH4832C00TR Datasheet



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Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	32
Program Memory Size	32KB (32K x 8)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	48-BSSOP (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323hah4832c00tr

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Revision History

Each instance in Table 1 reflects a change to this document from its previous revision. To see more detail, click the appropriate link in the table.

Table 1.	Revision	History	of this	Document
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Date	Revision Level	Section	Description	Page #
December 2004	02	Changed low power consumption, STOP and HALT mode current values, deleted mask option note, clarified temperature ranges in Tables 6 and 8 and 10. Added new Tables 9 and 10. Also added Characterization data to Table 11 and changed Program/Erase Endurance value in Table 12.		11,12,
		Removed Preliminar	y designation	All
March 2005	03	Minor change to Tab pin CDIP parts in the	le 9 Electrical Characteristics. Added 20, 28 and 40- ordering Section.	11,90





	-			
		\bigcirc		
NC			40	⊐ NC
P25	2		39	⊐ P24
P26	- 3		38	⊐ P23
P27	4		37	⊐ P22
P04	5		36	コ P21
P05	6		35	⊐ P20
P06	7		34	□ P03
P14	8	40-Pin	33	コ P13
P15	9	PDIP	32	⊐ P12
P07	10	CDIP*	31	⊐ VSS
VDD	11		30	⊐ P02
P16	12		39	⊐ P11
P17	13		28	コ P10
XTAL2	14		27	D P01
XTAL1	15		26	D P00
P31	16		25	□ Pref1/P30
P32	17		24	⊐ P36
P33	18		23	D P37
P34	19		22	⊐ P35
NC	20		21	RESET

Figure 5. 40-Pin PDIP/CDIP* Pin Configuration

Note: *Windowed Cerdip. These units are intended to be used for engineering code development only. ZiLOG does not recommend/guarantee this package for production use.



Absolute Maximum Ratings

Stresses greater than those listed in Table 8 might cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period might affect device reliability.

Table 7. Absolute Maximum Ratings

Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	-40	125	° C	1
Storage temperature	-65	+150	° C	
Voltage on any pin with respect to V_{SS}	-0.3	7.0	V	2
Voltage on V_{DD} pin with respect to V_{SS}	-0.3	7.0	V	
Maximum current on input and/or inactive output pin	-5	+5	μA	
Maximum output current from active output pin	-25	+25	mA	
Maximum current into V_{DD} or out of V_{SS}		75	mA	
Natas:				

Notes:

1. See Ordering Information.

2. This voltage applies to all pins except the following: V_{DD}, P32, P33 and RESET.

Standard Test Conditions

The characteristics listed in this product specification apply for standard test conditions as noted. All voltages are referenced to GND. Positive current flows into the referenced pin (see Figure 7).

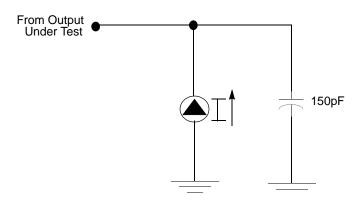


Figure 7. Test Load Diagram



Table 11. GP323HA DC Characteristics

			T _A = -40°C	C to +12	5°C			
Symbol	Parameter	V _{CC}	Min	Typ(7)	Max	Units	Conditions	Notes
V _{CC}	Supply Voltage		2.0		5.5	V	See Note 5	5
V _{CH}	Clock Input High Voltage	2.0-5.5	0.8 V _{CC}		V _{CC} +0.3	V	Driven by External Clock Generator	
V _{CL}	Clock Input Low Voltage	2.0-5.5	V _{SS} -0.3		0.4	V	Driven by External Clock Generator	
V _{IH}	Input High Voltage	2.0-5.5	0.7 V _{CC}		V _{CC} +0.3	V		
V _{IL}	Input Low Voltage	2.0-5.5	V _{SS} 0.3		0.2 V _{CC}	V		
V _{OH1}	Output High Voltage	2.0-5.5	V _{CC} -0.4			V	I _{OH} = -0.5mA	
V _{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-5.5	V _{CC} -0.8			V	I _{OH} = -7mA	
V _{OL1}	Output Low Voltage	2.0-5.5			0.4	V	$I_{OL} = 4.0 \text{mA}$	
V _{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-5.5			0.8	V	I _{OL} = 10mA	
V _{OFFSET}	Comparator Input Offset Voltage	2.0-5.5			25	mV		
V _{REF}	Comparator Reference Voltage	2.0-5.5	0		V _{DD} -1.75	V		
Ι _{ΙL}	Input Leakage	2.0-5.5	-1		1	μΑ	V _{IN} = 0V, V _{CC} Pull-ups disabled	
R _{PU}	Pull-up Resistance	2.0V	200		700	KΩ	V _{IN} = 0V; Pullups selected by mask	(
		3.6V	50		300	KΩ	option	
		5.0V	25		175	KΩ	_	
I _{OL}	Output Leakage	2.0-5.5	-1		1	μA	$V_{IN} = 0V, V_{CC}$	
I _{CC}	Supply Current	2.0V		1	3	mA	at 8.0 MHz	1, 2
		3.6V		5	10	mA	at 8.0 MHz	1,2
	0	5.5V		10	15	mA	at 8.0 MHz	1, 2
I _{CC1}	Standby Current	2.0V		0.5	1.6	mA m A	$V_{IN} = 0V$, Clock at 8.0MHz	1, 2, 6
	(HALT Mode)	3.6V 5.5V		0.8 1.3	2.0 3.2	mA mA	$V_{IN} = 0V$, Clock at 8.0MHz $V_{IN} = 0V$, Clock at 8.0MHz	1, 2, 6 1, 2, 6
1	Standby Current (Stop	2.0V		1.6	15	μΑ	$V_{IN} = 0 V$, V_{CC} WDT not Running	3
I _{CC2}	Mode)	2.6V 3.6V		1.8	20	μA μA	$V_{IN} = 0 V, V_{CC} WDT not Running$ $V_{IN} = 0 V, V_{CC} WDT not Running$	3
	wode)	5.5V		1.9	25	μA	$V_{IN} = 0 V$, V_{CC} WDT not Running	3
		2.0V		5	30	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		3.6V		8	40	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		5.5V		15	60	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
I _{LV}	Standby Current (Low Voltage)			1.2	6	μA	Measured at 1.3V	4
V _{BO}	V _{CC} Low Voltage Protection			1.9	2.15	V	8MHz maximum Ext. CLK Freq.	
V _{LVD}	V _{CC} Low Voltage Detection			2.4		V	•	



17

				–40°C to –40°C to	o +70°C (S) +105°C (E) +125°C (A) MHz			Watch-Dog Timer Mode Register
No	Symbol	Parameter	V _{CC}	Minimum	Maximum	Units	Notes	(D1, D0)
1	ТрС	Input Clock Period	2.0–5.5	121	DC	ns	1	
2	TrC,TfC	Clock Input Rise and Fall Times	2.0–5.5		25	ns	1	
3	TwC	Input Clock Width	2.0–5.5	37		ns	1	
4	TwTinL	Timer Input Low Width	2.0 5.5	100 70		ns	1	
5	TwTinH	Timer Input High Width	2.0–5.5	3TpC			1	
6	TpTin	Timer Input Period	2.0–5.5	8TpC			1	
7	TrTin,TfTin	Timer Input Rise and Fall Timers	2.0–5.5		100	ns	1	
8	TwIL	Interrupt Request Low Time	2.0 5.5	100 70		ns	1, 2	
9	TwlH	Interrupt Request Input High Time	2.0–5.5	5TpC			1, 2	
10	Twsm	Stop-Mode Recovery Width	2.0–5.5	12		ns	3	
		Spec		5TpC			4	
11	Tost	Oscillator Start-Up Time	2.0–5.5		5TpC		4	
12	Twdt	Watch-Dog Timer Delay Time	2.0–5.5 2.0–5.5 2.0–5.5 2.0–5.5	5 10 20 80		ms ms ms ms		0, 0 0, 1 1, 0 1, 1
13	T _{POR}	Power-On Reset	2.0–5.5	2.5	10	ms		

Table 13. AC Characteristics

Notes:

1. Timing Reference uses 0.9 V_{CC} for a logic 1 and 0.1 V_{CC} for a logic 0. 2. Interrupt request through Port 3 (P33–P31).

3. SMR – D5 = 1.

4. SMR - D5 = 0.



Pin Functions

XTAL1 Crystal 1 (Time-Based Input)

This pin connects a parallel-resonant crystal or ceramic resonator to the on-chip oscillator input. Additionally, an optional external single-phase clock can be coded to the on-chip oscillator input.

XTAL2 Crystal 2 (Time-Based Output)

This pin connects a parallel-resonant crystal or ceramic resonant to the on-chip oscillator output.

Port 0 (P07-P00)

Port 0 is an 8-bit, bidirectional, CMOS-compatible port. These eight I/O lines are configured under software control as a nibble I/O port. The output drivers are push-pull or open-drain controlled by bit D2 in the PCON register.

If one or both nibbles are needed for I/O operation, they must be configured by writing to the Port 0 mode register. After a hardware reset, Port 0 is configured as an input port.

An optional pull-up transistor is available as a mask option on all Port 0 bits with nibble select.

Notes: Internal pull-ups are disabled on any given pin or group of port pins when programmed into output mode.

The Port 0 direction is reset to its default state following an SMR.



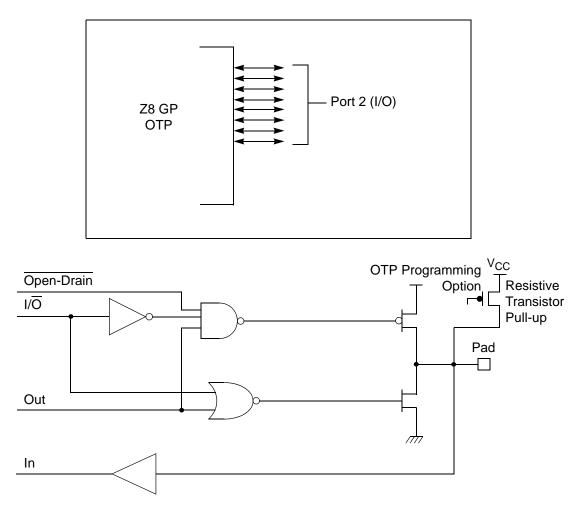


Figure 11. Port 2 Configuration

Port 3 (P37–P30)

Port 3 is a 8-bit, CMOS-compatible fixed I/O port (see Figure 12). Port 3 consists of four fixed input (P33–P30) and four fixed output (P37–P34), which can be configured under software control for interrupt and as output from the counter/timers. P30, P31, P32, and P33 are standard CMOS inputs; P34, P35, P36, and P37 are push-pull outputs.



CTR1(0D)01H" on page 35). Other edge detect and IRQ modes are described in Table 14.

Note: Comparators are powered down by entering Stop Mode. For P31–P33 to be used in a Stop Mode Recovery (SMR) source, these inputs must be placed into digital mode.

Pin	I/O	Counter/Timers	Comparator	Interrupt
Pref1/P30	IN		RF1	
P31	IN	IN	AN1	IRQ2
P32	IN		AN2	IRQ0
P33	IN		RF2	IRQ1
P34	OUT	Т8	AO1	
P35	OUT	T16		
P36	OUT	T8/16		
P37	OUT		AO2	
P20	I/O	IN		

Table 14. Port 3 Pin Function Summary

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Port 3 also provides output for each of the counter/timers and the AND/OR Logic (see Figure 13). Control is performed by programming bits D5–D4 of CTR1, bit 0 of CTR0, and bit 0 of CTR2.



ERF (Expanded Register File). Bits 7–4 of register RP select the working register group. Bits 3–0 of register RP select the expanded register file bank.

Note: An expanded register bank is also referred to as an expanded register group (see Figure 15).



The counter/timers are mapped into ERF group D. Access is easily performed using the following:

LD	RP, #0Dh	;	Select ERF D
for access to bank D			
		;	(working
register group 0)			
LD	R0,#xx	;	load CTR0
LD	1, #xx	;	load CTR1
LD	R1, 2	;	CTR2→CTR1
LD	RP, #0Dh	;	Select ERF D
for access to bank D			
		;	(working
register group 0)			
LD	RP, #7Dh	;	Select
expanded register bank	D and working	;	register
group 7 of bank 0 for a	ccess.		
LD	71h, 2		
; CTRL2 \rightarrow register 71h			
LD	R1, 2		
; CTRL2 \rightarrow register 71h			

Register File

>

The register file (bank 0) consists of 4 I/O port registers, 237 general-purpose registers, 16 control and status registers (R0–R3, R4–R239, and R240–R255, respectively), and two expanded registers groups in Banks D (see Table 15) and F. Instructions can access registers directly or indirectly through an 8-bit address field, thereby allowing a short, 4-bit register address to use the Register Pointer (Figure 17). In the 4-bit mode, the register file is divided into 16 working register groups, each occupying 16 continuous locations. The Register Pointer addresses the starting location of the active working register group.





Timers

T8_Capture_HI—HI8(D)0BH

This register holds the captured data from the output of the 8-bit Counter/Timer0. Typically, this register holds the number of counts when the input signal is 1.

Field	Bit Position		Description
T8_Capture_HI	[7:0]	R/W	Captured Data - No Effect

T8_Capture_LO—L08(D)0AH

This register holds the captured data from the output of the 8-bit Counter/Timer0. Typically, this register holds the number of counts when the input signal is 0.

Field	Bit Position		Description
T8_Capture_L0	[7:0]	R/W	Captured Data - No Effect

T16_Capture_HI—HI16(D)09H

This register holds the captured data from the output of the 16-bit Counter/ Timer16. This register holds the MS-Byte of the data.

Field	Bit Position		Description
T16_Capture_HI	[7:0]	R/W	Captured Data - No Effect

T16_Capture_LO—L016(D)08H

This register holds the captured data from the output of the 16-bit Counter/ Timer16. This register holds the LS-Byte of the data.

Field	Bit Position	Description
T16_Capture_LO	[7:0]	R/W Captured Data - No Effect

Counter/Timer2 MS-Byte Hold Register—TC16H(D)07H

Field	Bit Position		Description
T16_Data_HI	[7:0]	R/W	Data

ZGP323H Product Specification



Table 22. Stop Mode Recovery Source

SMR:432			Operation			
D4	D3	D2	Description of Action			
0	0	0	POR and/or external reset recovery			
0	0	1	Reserved			
0	1	0	P31 transition			
0	1	1	P32 transition			
1	0	0	P33 transition			
1	0	1	P27 transition			
1	1	0	Logical NOR of P20 through P23			
1	1	1	Logical NOR of P20 through P27			

Note: Any Port 2 bit defined as an output drives the corresponding input to the default state. This condition allows the remaining inputs to control the AND/OR function. Refer to SMR2 register on page 61 for other recover sources.

Stop Mode Recovery Delay Select (D5)

This bit, if Low, disables the T_{POR} delay after Stop Mode Recovery. The default configuration of this bit is 1. If the "fast" wake up is selected, the Stop Mode Recovery source must be kept active for at least 5 TpC.

Note: This bit must be set to 1 if using a crystal or resonator clock source. The T_{POR} delay allows the clock source to stabilize before executing instructions.

Stop Mode Recovery Edge Select (D6)

A 1 in this bit position indicates that a High level on any one of the recovery sources wakes the device from Stop Mode. A 0 indicates Low level recovery. The default is 0 on POR.

Cold or Warm Start (D7)

This bit is read only. It is set to 1 when the device is recovered from Stop Mode. The bit is set to 0 when the device reset is other than Stop Mode Recovery (SMR).





Low-Voltage Detection Register—LVD(D)0Ch

Note: Voltage detection does not work at Stop mode. It must be disabled during Stop mode in order to reduce current.

Field	Bit Position			Description
LVD	76543			Reserved No Effect
	2	R	1 0*	HVD flag set HVD flag reset
	1-	R	1 0*	LVD flag set LVD flag reset
	0	R/W	1 0*	Enable VD Disable VD
*Default	after POR			

Note: Do not modify register P01M while checking a low-voltage condition. Switching noise of both ports 0 and 1 together might trigger the LVD flag.

Voltage Detection and Flags

The Voltage Detection register (LVD, register 0CH at the expanded register bank 0Dh) offers an option of monitoring the V_{CC} voltage. The Voltage Detection is enabled when bit 0 of LVD register is set. Once Voltage Detection is enabled, the the V_{CC} level is monitored in real time. The flags in the LVD register valid 20uS after Voltage Detection is enabled. The HVD flag (bit 2 of the LVD register) is set only if V_{CC} is higher than V_{HVD}. The LVD flag (bit 1 of the LVD register) is set only if V_{CC} is lower than the V_{LVD}. When Voltage Detection is enabled, the LVD flag also triggers IRQ5. The IRQ bit 5 latches the low voltage condition until it is cleared by instructions or reset. The IRQ5 interrupt is served if it is enabled in the IMR register. Otherwise, bit 5 of IRQ register is latched as a flag only.

Notes: If it is necessary to receive an LVD interrupt upon power-up at an operating voltage lower than the low battery detect threshold, enable interrupts using the Enable Interrupt instruction (EI) prior to enabling the voltage detection.



Expanded Register File Control Registers (0D)

The expanded register file control registers (0D) are depicted in Figure 39 through Figure 43.

CTR0(0D)00H

			1	1		1		
D7	D6	D5	D4	D3	D2	D1	D0	
								 0 P34 as Port Output * 1 Timer8 Output 0 Disable T8 Timeout Interrupt * * 1 Enable T8 Timeout Interrupt 0 Disable T8 Data Capture Interrupt * * 1 Enable T8 Data Capture Interrupt * * 1 Enable T8 Data Capture Interrupt * * 1 Enable T8 Data Capture Interrupt 00 SCLK on T8* * 01 SCLK/2 on T8 10 SCLK/4 on T8 11 SCLK/8 on T8 R 0 No T8 Counter Timeout * * R 1 T8 Counter Timeout Occurred W 0 No Effect W 1 Reset Flag to 0 0 Modulo-N * 1 Single Pass R 0 T8 Disabled * R 1 T8 Enabled W 0 Stop T8 W 1 Enable T8

* Default setting after reset.

* * Default setting after Reset.. Not reset with a Stop-Mode recovery.

Figure 39. TC8 Control Register ((0D)O0H: Read/Write Except Where Noted)



LVD(0D)0CH



* Default setting after reset.

Figure 43. Voltage Detection Register

Note: Do not modify register P01M while checking a low-voltage condition. Switching noise of both ports 0 and 1 together might trigger the LVD flag.

Expanded Register File Control Registers (0F)

The expanded register file control registers (0F) are depicted in Figures 44 through Figure 57.



R254 SPH(FEH)



Figure 56. Stack Pointer High (FEH: Read/Write)

R255 SPL(FFH)



Stack Pointer Low Byte (SP7–SP0)

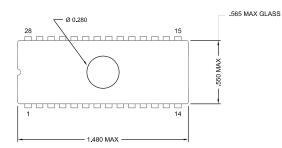
Figure 57. Stack Pointer Low (FFH: Read/Write)

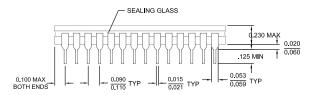
Package Information

Package information for all versions of ZGP323H is depicted in Figures 59 through Figure 68.









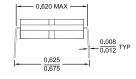
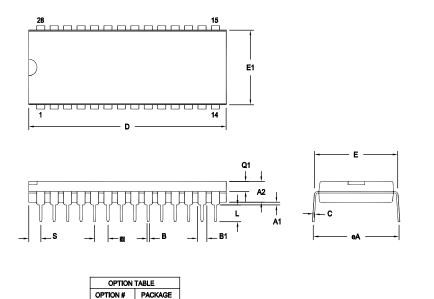
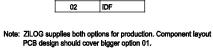


Figure 63. 28-Pin CDIP Package Diagram



SYMBOL	OPT #	MILLIN	IETER	INCH		
SIMDUL	OPT#	MíN	MAX	MÍN	MAX	
A1		0.38	1.02	.015	.040	
A2		3.18	4.19	.125	.165	
в		0.38	0.53	.015	.021	
B1	01	1.40	1.65	.055	.065	
	02	1.14	1.40	.045	.055	
С		0.23	0.38	.009	.015	
D	01	36.58	37.34	1.440	1.470	
-	02	35.31	35.94	1.390	1.415	
Е		15.24	15.75	.600	.620	
E1	01	13.59	14.10	.535	.555	
E1	02	12.83	13.08	.505	.515	
e		2.54	TYP	.100 BSC		
eA		15.49	16.76	.610	.660	
L		3.05	3.81	.120	.150	
Q1	01	1.40	1.91	.055	.075	
Q 1	02	1.40	1.78	.055	.070	
•	01	1.52	2.29	.060	.090	
S	02	1.02	1.52	.040	.060	

CONTROLLING DIMENSIONS : INCH



01

02

STANDARD

Figure 64. 28-Pin PDIP Package Diagram



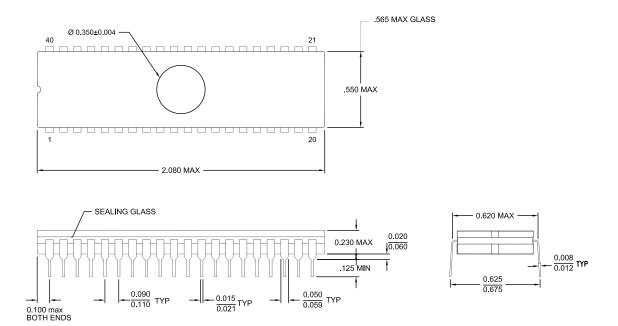


Figure 67. 40-Pin CDIP Package Diagram







Figure 68. 48-Pin SSOP Package Design

Note: Check with ZiLOG on the actual bonding diagram and coordinate for chip-on-board assembly.

ZGP323H Z8[®] OTP Microcontroller with IR Timers



28-pin DIP/SOIC/SSOP 6 40- and 48-pin 8 40-pin DIP 7 48-pin SSOP 8 pin functions port 0 (P07 - P00) 18 port 0 (P17 - P10) 19 port 0 configuration 19 port 1 configuration 20 port 2 (P27 - P20) 20 port 2 (P37 - P30) 21 port 2 configuration 21 port 3 configuration 22 port 3 counter/timer configuration 24 reset) 25 XTAL1 (time-based input 18 XTAL2 (time-based output) 18 ping-pong mode 48 port 0 configuration 19 port 0 pin function 18 port 1 configuration 20 port 1 pin function 19 port 2 configuration 21 port 2 pin function 20 port 3 configuration 22 port 3 pin function 21 port 3counter/timer configuration 24 port configuration register 55 power connections 3 power supply 5 program memory 25 map 26 R ratings, absolute maximum 10 register 61 CTR(D)01h 35 CTR0(D)00h 33 CTR2(D)02h 37 CTR3(D)03h 39 flag 80 HI16(D)09h 32

HI8(D)0Bh 32 interrupt priority 78 interrupt request 79 interruptmask 79 L016(D)08h 32 L08(D)0Ah 32 LVD(D)0Ch 65 pointer 80 port 0 and 1 77 port 2 configuration 75 port 3 mode 76 port configuration 55, 75 SMR2(F)0Dh 40 stack pointer high 81 stack pointer low 81 stop mode recovery 57 stop mode recovery 2 61 stop-mode recovery 73 stop-mode recovery 274 T16 control 69 T8 and T16 common control functions 67 T8/T16 control 70 TC16H(D)07h 32 TC16L(D)06h 33 TC8 control 66 TC8H(D)05h 33 TC8L(D)04h 33 voltage detection 71 watch-dog timer 75 register description Counter/Timer2 LS-Byte Hold 33 Counter/Timer2 MS-Byte Hold 32 Counter/Timer8 Control 33 Counter/Timer8 High Hold 33 Counter/Timer8 Low Hold 33 CTR2 Counter/Timer 16 Control 37 CTR3 T8/T16 Control 39 Stop Mode Recovery2 40 T16 Capture LO 32 T8 and T16 Common functions 35 T8_Capture_HI 32